ABSOCIATION CONNECTING ELECTRONICS WOUSTRIES® International and Par	PC, Bannock	burn, Illinois. A	All rights reserved untions.	under both	This docume level parts, t	ent is a declar the declaration	ration of n encom	the substance passes all low	s within th er level ma	e manufactur aterials for w	rer listed ite hich the m	em. Note anufactur	: if the item is an as rer has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
Supplier Information															
Company name*	Company un	Company unique ID			Unique ID Authority					Response Date*					
onsemi											2024-05-01				
Contact Name T			Title - Contact			Phone - Contact*					Email - Contact*				
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com						
Authorized Representative* Tit			Title - Representative			Phone - Representative*				Email - Representative*					
Product-Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Requester Item Number	er Mfr Item		m Number Mfr Item Name				ate Ve	e Version N		Manufacturing Site		Veight*	UOM	Unit Type	
	74VHC	139MTCX	Dual 2-to-4 Decoder/Demux			2024-05-01 PH1			56.427		mg	Each			
Ianufacturing Proccess Informa	tion												I	1	
Terminal Plating / Grid Array M	aterial	Terminal Base	Alloy	J-STD-020 MSL Rating		Peak Process Body Tem		ody Temperat	ature Max Time at Peak		Temperatu	perature Number of Reflow Cycles		cles	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С	30 s		second	ls 3			
omments															
vel 1 - maximum time at peak temperati	ire during so	ldering is 10-3	0 seconds												
or more information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.74	mg	Supplier	Silicon (Si)	7440-21-3		0.74	mg
Die Attach	0.084	mg		Epoxy resin	proprietary data		0.0084	mg
			Supplier	Silver (Ag)	7440-22-4		0.0672	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.0084	mg
Lead Frame	23.228	mg	Supplier	Zinc (Zn)	7440-66-6		0.0279	mg
			Supplier	Iron (Fe)	7439-89-6		0.5459	mg
			Supplier	Copper (Cu)	7440-50-8		22.6473	mg
			Supplier	Phosphorus (P)	7723-14-0		0.007	mg
Mold Compound-Black	31.8	mg		Epoxy resin	proprietary data		1.59	mg
			Supplier	Phenolic Resin	Proprietary Data		0.636	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.795	mg
			Supplier	Carbon Black (C)	1333-86-4		0.159	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		28.62	mg
Plating	0.178	mg	Supplier	Palladium (Pd)	7440-05-3		0.005	mg
			В	Nickel (Ni)	7440-02-0		0.17	mg
			Supplier	Gold (Au)	7440-57-5		0.003	mg
Wire Bond - Au	0.397	mg	Supplier	Gold (Au)	7440-57-5		0.397	mg